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Part Number: [0432028826](#)
Status: **Active**
Overview: [modular_plugs_jacks](#)
Description: Modular Jack, Right Angle, Low Profile, Shielded, Offset Panel Grounding Tabs, without Bottom Grounding Tab, Rear Position PCB Ground Tab, 8/8

Documents:

3D Model	Product Specification PS-43202-001 (PDF)
Drawing (PDF)	RoHS Certificate of Compliance (PDF)

Agency Certification

CSA	LR19980
UL	E107635

General

Product Family	Modular Jacks/Plugs
Series	43202
Component Type	PCB Jack
Magnetic	No
Overview	modular_plugs_jacks
Performance Category	3
Power over Ethernet (PoE)	N/A
Product Name	RJ45

Physical

Color - Resin	Black
Durability (mating cycles max)	500
Flammability	94V-0
Inverted / Top Latch	No
Lightpipes/LEDs	None
Material - Metal	Brass, Phosphor Bronze
Material - Plating Mating	Gold
Material - Plating Termination	Tin
Material - Resin	High Temperature Thermoplastic
Orientation	Right Angle (Side Entry)
PCB Retention	Yes
PCB Thickness Recommended (in)	0.062 In
PCB Thickness Recommended (mm)	1.60 mm
Packaging Type	Tray
Pitch - Mating Interface (in)	0.050 In
Pitch - Mating Interface (mm)	1.27 mm
Plating min: Mating (µin)	50
Plating min: Mating (µm)	1.25
Plating min: Termination (µin)	100
Plating min: Termination (µm)	2.5
Ports	1
Positions / Loaded Contacts	8/8
Surface Mount Compatible (SMC)	Yes
Temperature Range - Operating	-40°C to +85°C
Termination Interface: Style	Through Hole
Wire/Cable Type	N/A

Electrical

Current - Maximum per Contact	1.5A
Grounding to PCB	Yes
Grounding to Panel	Offset Panel Ground Tabs

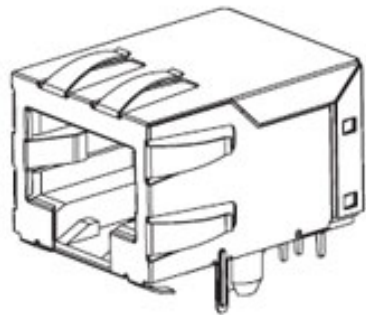


image - Reference only

Series

EU RoHS

**ELV and RoHS
Compliant**
REACH SVHC
Not Reviewed
**Halogen-Free
Status**
Not Reviewed

China RoHS



**Need more information on product
environmental compliance?**

Email productcompliance@molex.com
For a multiple part number RoHS Certificate of
Compliance, [click here](#)

Please visit the [Contact Us](#) section for any
non-product compliance questions.

Search Parts in this Series
[43202Series](#)

Mates With
FCC 68 Plugs

Shielded
Voltage - Maximum

Yes
125V

Solder Process Data

Lead-free Process Capability

Wave Capable (TH only)

Material Info

Reference - Drawing Numbers

Packaging Specification
Product Specification
Sales Drawing

PK-43202-004
PS-43202-001, RPS-43202-002
SDA-43202

This document was generated on 06/07/2010

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NOTES:

1) MATERIAL:

HOUSING: NYLON(PA), GLASS FILLED, UL94V-0, COLOR: SEE SHEETS 5 AND 6
INSULATOR: NYLON(PA), GLASS FILLED, UL94V-0, COLOR: SEE SHEETS 5 AND 6
TERMINALS: PHOSPHOR BRONZE, .012/ 0.30 THICK
SHIELD: BRASS, .007/ 0.18 THICK

2) FINISH:

TERMINALS:

A = SELECT GOLD IN CONTACT AREA: 50 MICROINCHES / 1.27 MICROMETERS MIN.,
*SELECT TIN IN PC TAIL AREA: 100 MICROINCHES / 2.54 MICROMETERS MIN.,
WITH OVERALL NICKEL UNDERPLATE: 50 MICROINCHES / 1.27 MICROMETERS MIN.
B = SELECT GOLD IN CONTACT AREA: 30 MICROINCHES / 0.76 MICROMETERS MIN.,
*SELECT TIN IN PC TAIL AREA: 100 MICROINCHES / 2.54 MICROMETERS MIN.,
WITH OVERALL NICKEL UNDERPLATE: 50 MICROINCHES / 1.27 MICROMETERS MIN.
*THE PRIMARY SHIPPING CARTON WILL BE LABELED "COMPLIANT TO RoHS
DIRECTIVE 2002/95/EC AND ELV ANNEX II OF DIRECTIVE 2000/53/EC".
CARTONS WITHOUT THIS LABEL MAY CONTAIN PRODUCT WITH TIN-LEAD
IN THE PC TAILS AND/OR SHIELD.

SHIELD:

100 MICROINCHES / 2.54 MICROMETERS NICKEL OVER 50 MICROINCHES / 1.27
MICROMETERS COPPER UNDERPLATE PCB GROUND TABS DIPPED IN TIN

3) PRODUCT SPECIFICATION AND PROCESSING PARAMETERS: PS-43202.

4) PACKAGING SPECIFICATION:

UNSHIELDED CONNECTOR ASSEMBLIES PACKAGED IN THERMOFORMED TRAYS
PER MOLEX PACKAGING SPECIFICATION PK-43202-003.
UNSHIELDED CONNECTOR ASSEMBLIES PACKAGED IN TUBES
PER MOLEX PACKAGING SPECIFICATION PK-43202-005.
SHIELDED CONNECTOR ASSEMBLIES PACKAGED IN THERMOFORMED TRAYS
PER MOLEX PACKAGING SPECIFICATION PK-43202-004.

5) SEE SHEETS 7 - 9 FOR P.C. BOARD LAYOUTS.

6) CONFORMS TO FCC REGULATION PART 68.5 FOR MODULAR JACKS.

7) THIS PART CONFORMS TO CLASS B REQUIREMENTS OF COSMETIC
SPECIFICATION PS-45499-002.



SHIELDED MODULAR JACK
SHOWN WITH PANEL GROUND
OPTION 'D' AND FRONT
PCB GROUND TABS.

DRAWING LEGEND

SHEET 1- NOTES, DRAWING LEGEND
SHEET 2- SHIELDED MODULAR JACK W/ BOTTOM GROUND TABS
SHEET 3- SHIELDED MODULAR JACK W/O BOTTOM GROUND TABS
SHEET 4- UNSHIELDED MODULAR JACK
SHEET 5- PART NUMBER CHARTS
SHEET 6- PART NUMBER CHARTS
SHEET 7- FOOTPRINT LAYOUT FOR 4 POSITION HOUSING
SHEET 8- FOOTPRINT LAYOUT FOR 6 POSITION HOUSING
SHEET 9- FOOTPRINT LAYOUT FOR 8 POSITION HOUSING

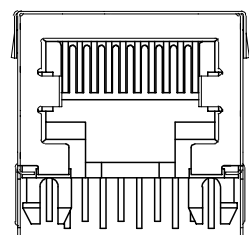
OBS COLORED JACKS EC NO: UCP2008-1189 DRAWN:JBELL 2007/11/30 CHKD:LSCHMIDT 2008/02/20 APPR:FSM/TH 2008/03/04	QUALITY SYMBOLS ▽=0 ▽=0	DESCRIPTION REV	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE IN/MM		SCALE 4:1	DESIGN UNITS INCH	 THIRD ANGLE PROJECTION	TITLE ULTRA LOW PROFILE RIGHT ANGLE MODULAR JACK ASSEMBLY MOLEX INCORPORATED	DOCUMENT NO. SDA-43202	SHEET NO. 1 OF 9		
				mm	INCH	DRAWN BY JTR	DATE 1993/03/31							
			4 PLACES	± ---	± ---	CHECKED BY JTR	DATE 1993/03/31							
			3 PLACES	± ---	± .010									
			2 PLACES	± 0.25	± .014									
			1 PLACE	± 0.36	± ---									
			ANGULAR ±1/2°		APPROVED BY RAS		DATE 1993/03/31							
			DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		MATERIAL NO. SEE SHTS 5&6		SIZE							
							THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION							

9	L2
8	L2
7	L2
6	L4
5	L
4	K2
3	L1
2	L1
1	L4
SH	REV

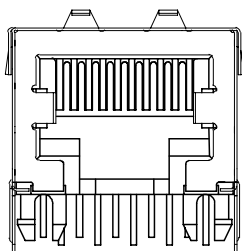
SHIELDED MODULAR JACK W/O BOTTOM GROUND TABS

SIZE 8, LOADED 10 VERSION SHOWN

SIDE/TOP GROUND TAB OPTIONS FOR SHIELDS



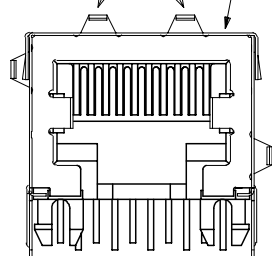
OPTION "E"
NO TOP OR SIDE TABS



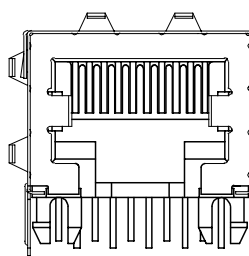
OPTION "F"
TOP TABS

OPTIONAL TOP GROUND TABS

SHIELDED MODULAR JACK ASSEMBLY
SEE SHEET 6 FOR MATERIAL NO.

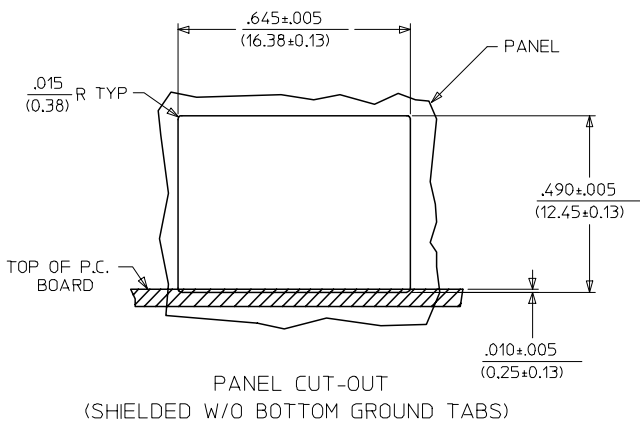


OPTION "G"
TOP AND STAGGERED SIDE TABS

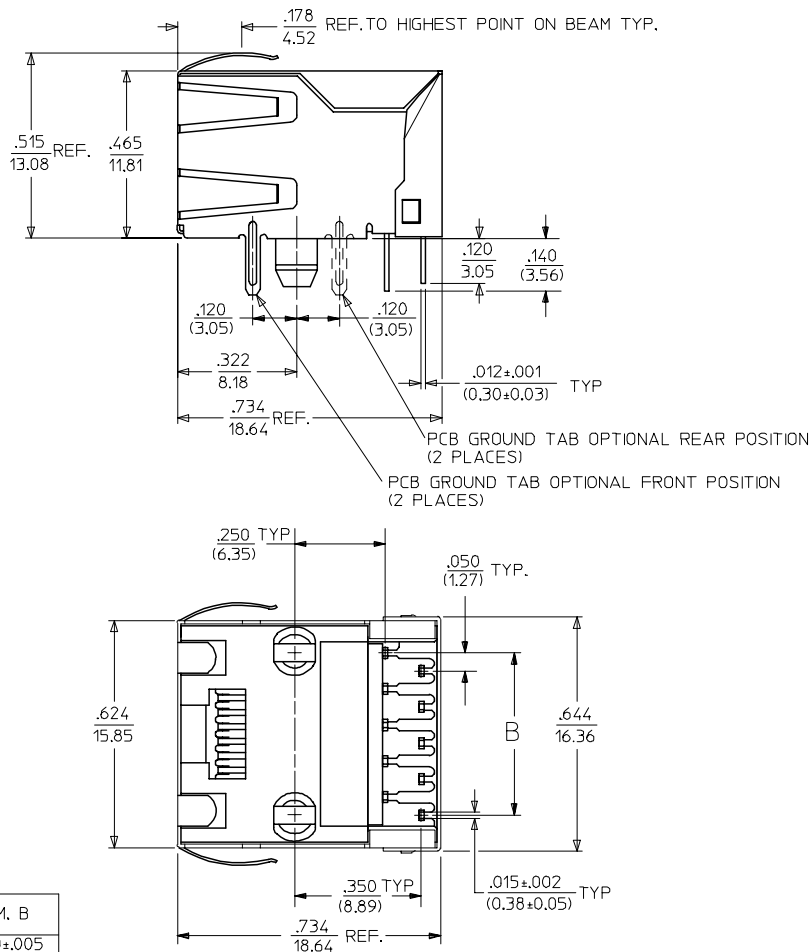


OPTION "H"
TOP AND SIDE TABS

OPTIONAL SIDE
GROUND TABS
(2 PLACES)

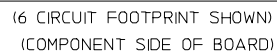
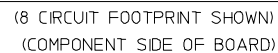
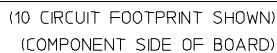


HOUSING SIZE	CIRCUIT SIZE	DIM. B
8	10	.450±.005 (11.43±0.13)
8	8	.350±.005 (8.89±0.13)



SEE SHEET ONE EC NO: UCP2004-1888 DRAWN: SCHMIDT 2004/03/31 CHKD: SCHMIDT 2004/03/31 APPR: FSMITH 2004/03/31 L1	DESCRIPTION	QUALITY SYMBOLS -0 -0	GENERAL TOLERANCES (UNLESS SPECIFIED)		SCALE 4:1	DESIGN UNITS INCH	 THIRD ANGLE PROJECTION REVISE ON CAD ONLY	TITLE ULTRA LOW PROFILE RIGHT ANGLE MODULAR JACK ASSEMBLY  MOLEX INCORPORATED		
				mm	INCH	DIMENSION STYLE IN/MM				
			4 PLACES	± ---	± ---	DRAWN BY JTR			DATE 1993/03/31	
			3 PLACES	± ---	± .010	CHECKED BY JTR			DATE 1993/03/31	
			2 PLACES	± 0.25	± .014					
			1 PLACE	± 0.36	± ---	APPROVED BY RAS			DATE 1993/03/31	
			ANGULAR ±1/2°			MATERIAL NO. SEE SHT 6			DOCUMENT NO. SDA-43202	SHEET NO. 3 OF 9
			DRAFT WHERE APPLICABLE			THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION				
			MUST REMAIN WITHIN DIMENSIONS							

[illegible]



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Rev. C 2002/05/05